



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: L-0501-04		DATE: 1/28/2005	MEANS OF DISTINGUISHING CHANGED DEVICES:	
Product Affected: IDT74SSTVF16859NL IDT74SSTVF16859NLG			<input type="checkbox"/> Product Mark <input type="checkbox"/> Back Mark <input checked="" type="checkbox"/> Date Code "0510" and later <input type="checkbox"/> Other	
Date Effective: 2/28/2005				
Contact:	Bimla Paul	Attachment::	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
Title:	Quality Assurance Manager	Samples:	See attachment	
Phone #:	(408)-654-6419			
Fax #:	(408)-492-8362			
E-mail:	bimla.paul@idt.com			
DESCRIPTION AND PURPOSE OF CHANGE:				
<input type="checkbox"/> Die Technology <input type="checkbox"/> Wafer Fabrication Process <input type="checkbox"/> Assembly Process <input type="checkbox"/> Equipment <input checked="" type="checkbox"/> Material To standardize the exposed bottom pad dimensions at different assembly locations for NL/NLG56 packages. <input type="checkbox"/> Testing <input type="checkbox"/> Manufacturing Site <input type="checkbox"/> Data Sheet <input type="checkbox"/> Other				
RELIABILITY/QUALIFICATION SUMMARY:				
Please see attachment for reliability/qualification data.				
CUSTOMER ACKNOWLEDGMENT OF RECEIPT:				
IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.				
Customer:	_____	<input type="checkbox"/>	<i>Approval for shipments prior to effective date.</i>	
Name/Date:	_____	E-Mail Address:	_____	
Title:	_____	Phone# /Fax# :	_____	
CUSTOMER COMMENTS: _____				
IDT ACKNOWLEDGMENT OF RECEIPT:				
RECD. BY:	_____	DATE:	_____	



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ATTACHMENT - PCN #: L-0501-04

PCN Type: Standardize exposed bottom pad dimension

Data Sheet Change: There is change in Moisture Sensitive Level from level 3 to level 1.

Detail of Change: NL/NLG56 package is assembled at different assembly locations. This PCN is being issued to notify customer that the exposed bottom pad dimensions will be standardized as follow:

Description	From	To
Exposed Bottom Pad	6.0 x 4.8 mm	5.1 x 4.4 mm
Inside Die Pad	5.0 x 6.2 mm	4.65 x 5.35 mm

This change will be implemented on all products assembled at ASAT with date code (0510) or later. There will be a change in moisture sensitive level from level 3 to level 1.

The affected products are as follow:

IDT74SSTVF16859NL	IDT74SSTVF16859NLG
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Qualification Plan: P04-09-02
Test Vehicle: IDT74SSTVN16859
Qualification Test Plan and Results:

Test Descriptions	Test Methods	Sample size /# Fails	Test results NLG56
Moisture Sensitive Level	J-STD-020B	90/0	90/0
Physical Dimensions	JESD22-B100-B	5/0	5/0